# 1-TO-5 DIFFERENTIAL-TO-3.3V LVPECL ZERO DELAY BUFFER

### GENERAL DESCRIPTION



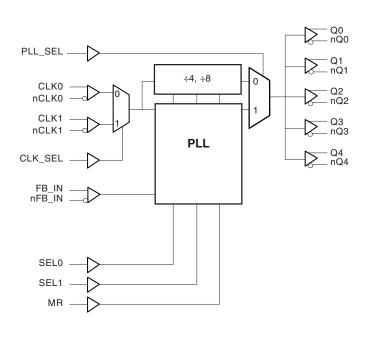
The ICS8634-01 is a high performance 1-to-5 Differential-to-3.3V LVPECL zero delay buffer and a member of the HiPerClockS™ family of High Performance Clock Solutions from ICS. The ICS8634-01 has two selectable clock inputs. The

CLKx, nCLKx pair can accept most standard differential input levels. Utilizing one of the outputs as feedback to the PLL, output frequencies up to 700MHz can be regenerated with zero delay with respect to the input. Dual reference clock inputs support redundant clock or multiple reference applications.

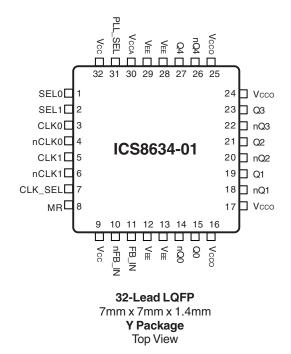
### **F**EATURES

- 5 differential 3.3V LVPECL outputs
- · Selectable differential clock inputs
- CLKx, nCLKx pair can accept the following differential input levels: LVDS, LVPECL, LVHSTL, SSTL, HCSL
- Output frequency range: 31.25MHz 700MHz
- Input frequency range: 31.25MHz 700MHz
- VCO range: 250MHz 700MHz
- External feedback for "zero delay" clock regeneration
- Cycle-to-cycle jitter: 25ps (maximum)
- Output skew: 25ps (maximum)
- PLL reference zero delay: 50ps ± 100ps
- · 3.3V operating supply
- 0°C to 70°C ambient operating temperature
- Industrial temperature information available upon request

### **BLOCK DIAGRAM**



### PIN ASSIGNMENT



# ICS8634-01 1-to-5 Differential-to-3.3V LVPECL Zero Delay Buffer

TABLE 1. PIN DESCRIPTIONS

Number	Name	T	уре	Description
1	SEL0	Input	Pulldown	Determines output divider values in Table 3. LVCMOS / LVTTL interface levels.
2	SEL1	Input	Pulldown	Determines output divider values in Table 3. LVCMOS / LVTTL interface levels.
3	CLK0	Input	Pulldown	Non-inverting differential clock input.
4	nCLK0	Input	Pullup	Inverting differential clock input.
5	CLK1	Input	Pulldown	Non-inverting differential clock input.
6	nCLK1	Input	Pullup	Inverting differential clock input.
7	CLK_SEL	Input	Pulldown	Clock select input. When LOW, selects CLK0, nCLK0. When HIGH, selects CLK1, nCLK1. LVCMOS / LVTTL interface levels.
8	MR	Input	Pulldown	Master reset. Resets the output divider. LVCMOS / LVTTL interface levels.
9, 32	V <sub>cc</sub>	Power		Positive supply pin. Connect to 3.3V.
10	nFB_IN	Input	Pullup	Feedback input to phase detector for regenerating clocks with "zero delay".
11	FB_IN	Input	Pulldown	Feedback input to phase detector for regenerating clocks with "zero delay".
12, 13 28, 29	V <sub>EE</sub>	Power		Negative supply pins. Connect to ground.
14, 15	nQ0, Q0	Output		Differential output pair. LVPECL interface levels.
16. 17, 24, 25	V <sub>cco</sub>	Power		Output supply pins. Connect to 3.3V.
18, 19	nQ1, Q1	Output		Differential output pair. LVPECL interface levels.
20, 21	nQ2, Q2	Output		Differential output pair. LVPECL interface levels.
22, 23	nQ3, Q3	Output		Differential output pair. LVPECL interface levels
26, 27	nQ4, Q4	Output		Differential output pair. LVPECL interface levels.
30	V <sub>CCA</sub>	Power		Analog supply pin. Connect to 3.3V.
31	PLL_SEL	Input	Pullup	Selects between the PLL and the reference clock as the input to the dividers. When HIGH, selects PLL. When LOW, selects reference clock. LVCMOS / LVTTL interface levels.

NOTE: Pullup and Pulldown refers to internal input resistors. See Table 2, Pin Characteristics, for typical values.

Table 2. Pin Characteristics

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C <sub>IN</sub>	Input Capacitance				4	pF
R <sub>PULLUP</sub>	Input Pullup Resistor			51		ΚΩ
R <sub>PULLDOWN</sub>	Input Pulldown Resistor			51		ΚΩ

# ICS8634-01 1-to-5 Differential-to-3.3V LVPECL

# ZERO DELAY BUFFER

TABLE 3A. CONTROL INPUT FUNCTION TABLE

		Outputs PLL_SEL = 1 PLL Enable Mode	
SEL1	SEL1 SEL0 Reference Frequency Range (MHz)*		Q0 - Q4, nQ0 - nQ4
0	0	250 - 700	÷ 1
0	1	125 - 350	÷ 1
1	0	62.5 - 175	÷ 1
1	1	31.25 - 87.5	÷ 1

<sup>\*</sup>NOTE: VCO frequency range for all configurations above is 250 to 700MHz.

TABLE 3B. PLL BYPASS FUNCTION TABLE

Inp	outs	Outputs PLL_SEL = 0 PLL Bypass Mode
SEL1	SEL0	Q0 - Q4, nQ0 - nQ4
0	0	÷ 4
0	1	÷ 4
1	0	÷ 4
1	1	÷ 8

# 1-TO-5 DIFFERENTIAL-TO-3.3V LVPECL ZERO DELAY BUFFER

### ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V<sub>CCx</sub> 4.6V

 $\begin{array}{ll} \text{Inputs, V}_{\text{I}} & -0.5\text{V to V}_{\text{CC}} + 0.5\text{ V} \\ \text{Outputs, V}_{\text{O}} & -0.5\text{V to V}_{\text{CCO}} + 0.5\text{V} \\ \text{Package Thermal Impedance, } \theta_{\text{JA}} & 47.9^{\circ}\text{C/W (0 lfpm)} \\ \text{Storage Temperature, T}_{\text{STG}} & -65^{\circ}\text{C to 150}^{\circ}\text{C} \end{array}$ 

Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Table 4A. Power Supply DC Characteristics,  $V_{CC} = V_{CCA} = V_{CCO} = 3.3V \pm 5\%$ ,  $T_A = 0^{\circ}C$  to  $70^{\circ}C$ 

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V <sub>cc</sub>	Positive Supply Voltage		3.135	3.3	3.465	V
V <sub>CCA</sub>	Analog Supply Voltage		3.135	3.3	3.465	V
V <sub>cco</sub>	Output Supply Voltage		3.135	3.3	3.465	V
I <sub>EE</sub>	Power Supply Current				150	mA
I <sub>CCA</sub>	Analog Supply Current				15	mA

Table 4B. LVCMOS DC Characteristics,  $V_{CC} = V_{CCA} = V_{CCO} = 3.3V \pm 5\%$ , Ta = 0°C to 70°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
V <sub>IH</sub>	Input High Voltage			2		V <sub>cc</sub> + 0.3	V
V <sub>IL</sub>	Input Low Voltage			-0.3		0.8	V
I <sub>IH</sub>	Input High Current	SEL0, SEL1, CLK_SEL, MR	$V_{CC} = V_{IN} = 3.465V$			150	μΑ
lin lin		PLL_SEL	$V_{CC} = V_{IN} = 3.465V$			5	μΑ
I <sub>II</sub>	Input Low Current	SEL0, SEL1, CLK_SEL, MR	$V_{CC} = 3.465V, V_{IN} = 0V$	-5			μΑ
IL	•	PLL_SEL	$V_{CC} = 3.465V, V_{IN} = 0V$	-150			μΑ

Table 4C. Differential DC Characteristics,  $V_{CC} = V_{CCA} = V_{CCO} = 3.3V \pm 5\%$ , Ta = 0°C to 70°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
	Input High Current	CLK0, CLK1, FB_IN	$V_{CC} = V_{IN} = 3.465V$			150	μΑ
¹ <sub>IH</sub>	Imput High Current	nCLK0, nCLK1, nFB_IN	$V_{CC} = V_{IN} = 3.465V$			5	μΑ
	Input Low Current	CLK0, CLK1, FB_IN	$V_{CC} = 3.465V, V_{IN} = 0V$	-5			μΑ
I <sub>IL</sub>	Input Low Current	nCLK0, nCLK1, nFB_IN	$V_{CC} = 3.465V, V_{IN} = 0V$	-150			μΑ
V <sub>PP</sub>	Peak-to-Peak Input Voltage			0.15		1.3	V
V <sub>CMR</sub>	Common Mode Input Voltage; NOTE 1, 2			V <sub>EE</sub> + 0.5		V <sub>cc</sub> - 0.85	V

NOTE 1: For single ended applications, the maximum input voltage for CLK0, nCLK0 and CLK1, nCLK1 is V<sub>cc</sub> + 0.3V.

NOTE 2: Common mode voltage is defined as  $\rm V_{IH}.$ 

# 1-TO-5 DIFFERENTIAL-TO-3.3V LVPECL ZERO DELAY BUFFER

Table 4D. LVPECL DC Characteristics,  $V_{CC} = V_{CCA} = V_{CCO} = 3.3V \pm 5\%$ , Ta = 0°C to 70°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V <sub>OH</sub>	Output High Voltage; NOTE 1		V <sub>cco</sub> - 1.4		V <sub>cco</sub> - 1.0	V
V <sub>OL</sub>	Output Low Voltage; NOTE 1		V <sub>cco</sub> - 2.0		V <sub>cco</sub> - 1.7	V
V <sub>SWING</sub>	Peak-to-Peak Output Voltage Swing		0.6		0.9	V

NOTE 1: Outputs terminated with  $50\Omega$  to  $V_{cco}$  - 2V.

### Table 5. Input Frequency Characteristics, $V_{CC} = V_{CCA} = V_{CCO} = 3.3V \pm 5\%$ , Ta = 0°C to 70°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
4	Input Fraguency	CLK0, nCLK0,	PLL_SEL = 1	31.25		700	MHz
IN	Input Frequency	CLK1, nCLK1	PLL_SEL = 0			700	MHz

### Table 6. AC Characteristics, $V_{CC} = V_{CCA} = V_{CCO} = 3.3V \pm 5\%$ , $T_A = 0$ °C to 70°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f <sub>MAX</sub>	Output Frequency				700	MHz
t <sub>PD</sub>	Propagation Delay; NOTE 1	PLL_SEL = 0V, f ≤ 700MHz	3.6	3.9	4.2	ns
t(Ø)	PLL Reference Zero Delay; NOTE 2, 4	PLL_SEL = 3.3V	-50	50	150	ps
tsk(o)	Output Skew; NOTE 3, 4				25	ps
tjit(cc)	Cycle-to-Cycle Jitter; NOTE 4, 6				25	ps
<i>t</i> jit(θ)	Phase Jitter; NOTE 4, 5, 6				±50	ps
t_	PLL Lock Time				1	ms
t <sub>R</sub>	Output Rise Time	20% to 80% @ 50MHz	300		700	ps
t <sub>F</sub>	Output Fall Time	20% to 80% @ 50MHz	300		700	ps
odc	Output Duty Cycle		47		53	%

All parameters measured at f<sub>MAX</sub> unless noted otherwise.

NOTE 1: Measured from the differential input crossing point to the differential output crossing point.

NOTE 2: Defined as the time difference between the input reference clock and the average feedback input signal when the PLL is locked and the input reference frequency is stable.

NOTE 3: Defined as skew between outputs at the same supply voltage and with equal load conditions.

Measured at the output differential cross points.

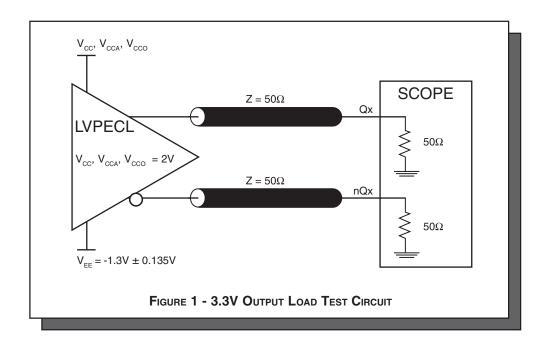
NOTE 4: This parameter is defined in accordance with JEDEC Standard 65.

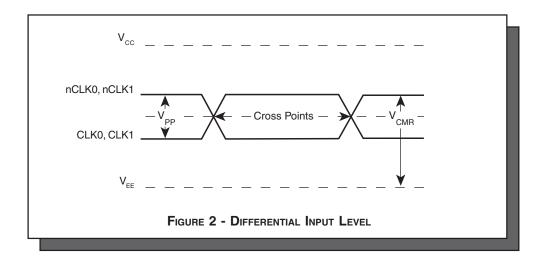
NOTE 5: Phase jitter is dependent on the input source used.

NOTE 6: Characterized at VCO frequency of 622MHz.



### PARAMETER MEASUREMENT INFORMATION

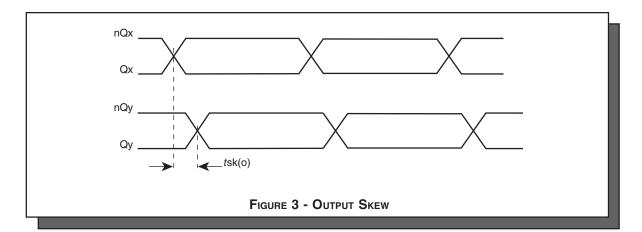


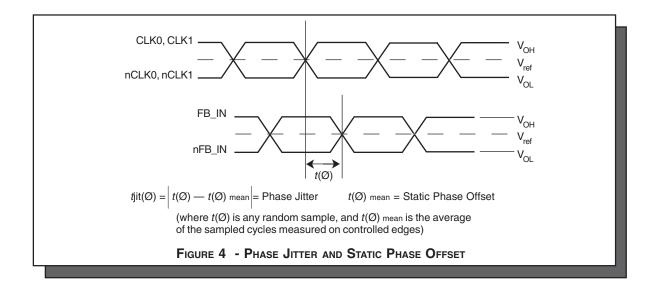


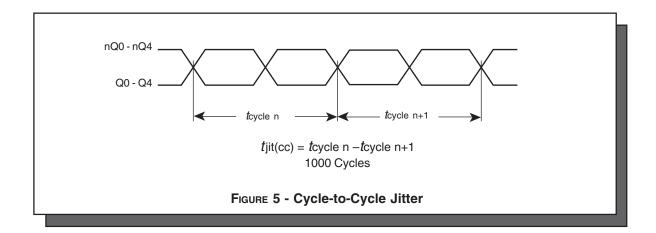
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### ICS8634-01

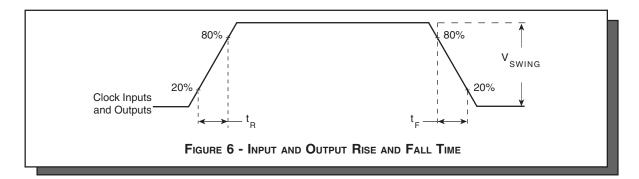
# 1-TO-5 DIFFERENTIAL-TO-3.3V LVPECL ZERO DELAY BUFFER

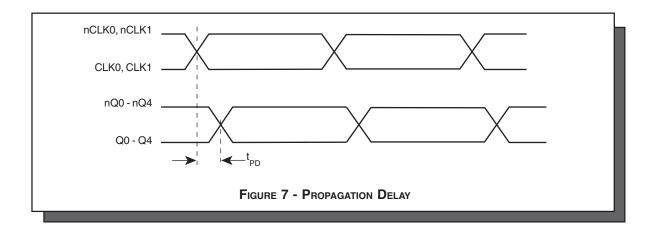


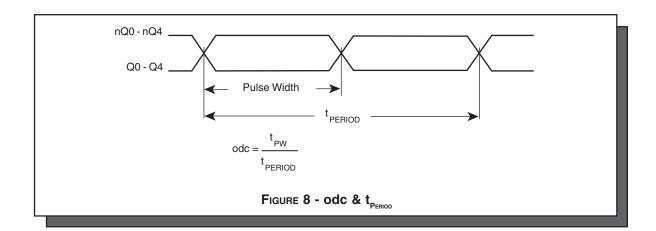




# 1-TO-5 DIFFERENTIAL-TO-3.3V LVPECL ZERO DELAY BUFFER



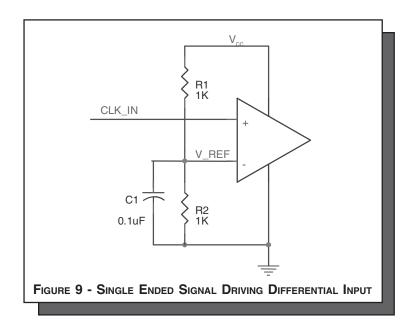




### ICS8634-01 1-TO-5 DIFFERENTIAL-TO-3.3V LVPECL ZERO DELAY BUFFER

# APPLICATION INFORMATION WIRING THE DIFFERENTIAL INPUT TO ACCEPT SINGLE ENDED LEVELS

Figure 9 shows how the differential input can be wired to accept single ended levels. The reference voltage  $V_{CC}/2$  is generated by the bias resistors R1, R2 and C1. This bias circuit should be located as close as possible to the input pin. The ratio of R1 and R2 might need to be adjusted to position the  $V_{REF}$  in the center of the input voltage swing. For example, if the input clock swing is only 2.5V and  $V_{CC} = 3.3V$ ,  $V_{REF}$  should be 1.25V and R2/R1 = 0.609.



# 1-TO-5 DIFFERENTIAL-TO-3.3V LVPECL ZERO DELAY BUFFER

#### LAYOUT GUIDELINE

The schematic of the ICS8634-01 layout example is shown in *Figure 10*. The ICS8634-01 recommended PCB board layout for this example is shown in *Figure 11*. This layout example is used as a general guideline. The layout in the actual system will depend on the selected component types, the density of the components, the density of the traces, and the stacking of the P.C. board.

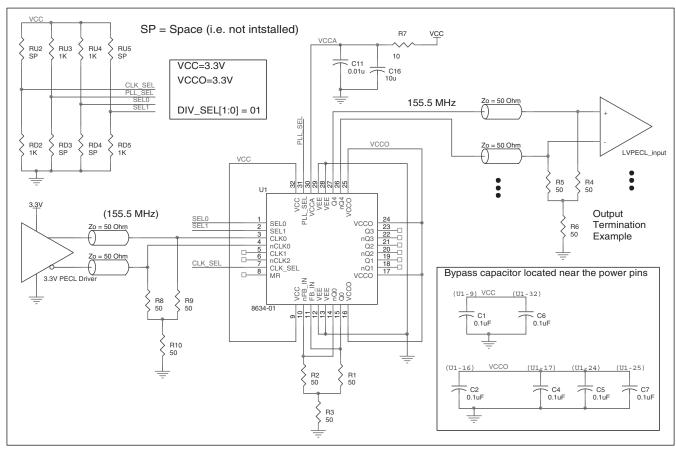


FIGURE 10. ICS8634-01 LVPECL ZERO DELAY BUFFER SCHEMATIC EXAMPLE

# 1-TO-5 DIFFERENTIAL-TO-3.3V LVPECL ZERO DELAY BUFFER

The following component footprints are used in this layout example:

All the resistors and capacitors are size 0603.

#### POWER AND GROUNDING

Place the decoupling capacitors C1, C2, C4, C5, C6, and C7, as close as possible to the power pins. If space allows, placement of the decoupling capacitor on the component side is preferred. This can reduce unwanted inductance between the decoupling capacitor and the power pin caused by the via.

Maximize the power and ground pad sizes and number of vias capacitors. This can reduce the inductance between the power and ground planes and the component power and ground pins.

The RC filter consisting of R7, C11, and C16 should be placed as close to the  $V_{\rm CGA}$  pin as possible.

### **CLOCK TRACES AND TERMINATION**

Poor signal integrity can degrade the system performance or cause system failure. In synchronous high-speed digital systems, the clock signal is less tolerant to poor signal integrity than other signals. Any ringing on the rising or falling edge or excessive ring back can cause system failure. The shape of the trace and the

trace delay might be restricted by the available space on the board and the component location. While routing the traces, the clock signal traces should be routed first and should be locked prior to routing other signal traces.

- The differential  $50\Omega$  output traces should have same length.
- Avoid sharp angles on the clock trace. Sharp angle turns cause the characteristic impedance to change on the transmission lines.
- Keep the clock traces on the same layer. Whenever possible, avoid placing vias on the clock traces. Placement of vias on the traces can affect the trace characteristic impedance and hence degrade signal integrity.
- To prevent cross talk, avoid routing other signal traces in parallel with the clock traces. If running parallel traces is unavoidable, allow a spearation of at least three trace widths between the differential clock trace and the other signal trace.
- Make sure no other signal traces are routed between the clock trace pair.
- The matching termination resistors should be located as close to the receiver input pins as possible.

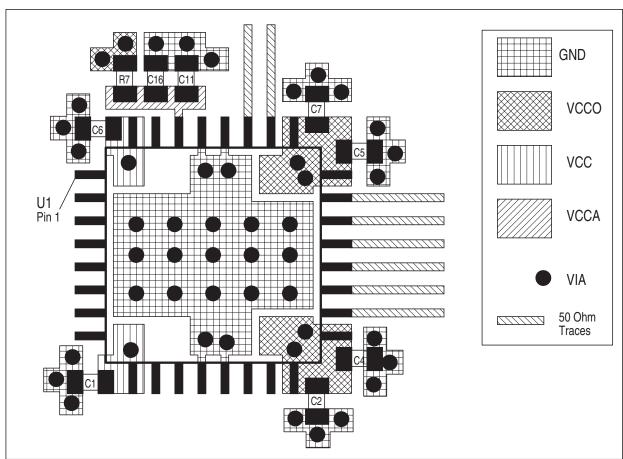


FIGURE 11. PCB BOARD LAYOUT FOR ICS8634-01

## 1-to-5 Differential-to-3.3V LVPECL Zero Delay Buffer

### **POWER CONSIDERATIONS**

This section provides information on power dissipation and junction temperature for the ICS8634-01. Equations and example calculations are also provided.

#### 1. Power Dissipation.

The total power dissipation for the ICS8634-01 is the sum of the core power plus the power dissipated in the load(s). The following is the power dissipation for  $V_{CC} = 3.3V + 5\% = 3.465V$ , which gives worst case results.

NOTE: Please refer to Section 3 for details on calculating power dissipated in the load.

- Power (core)<sub>MAX</sub> = V<sub>CC MAX</sub> \* I<sub>EE MAX</sub> = 3.465V \* 150mA = 520mW
- Power (outputs)<sub>MAX</sub> = 30.2mW/Loaded Output pair
   If all outputs are loaded, the total power is 5 \* 30.2mW = 151mW

**Total Power\_\_{MAX}** (3.465V, with all outputs switching) = 520mW + 151mW = **671mW** 

#### 2. Junction Temperature.

Junction temperature, Tj, is the temperature at the junction of the bond wire and bond pad and directly affects the reliability of the device. The maximum recommended junction temperature for HiPerClockS $^{TM}$  devices is 125°C.

The equation for Tj is as follows:  $Tj = \theta_{JA} * Pd\_total + T_A$ 

Tj = Junction Temperature

 $\theta_{1\Delta}$  = Junction-to-ambient thermal resistance

Pd\_total = Total device power dissipation (example calculation is in section 1 above)

 $T_{\Delta}$  = Ambient Temperature

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance  $\theta_{JA}$  must be used. Assuming a moderate air flow of 200 linear feet per minute and a multi-layer board, the appropriate value is 42.1°C/W per Table 7 below.

Therefore, Tj for an ambient temperature of  $70^{\circ}$ C with all outputs switching is:  $70^{\circ}$ C + 0.671W \*  $42.1^{\circ}$ C/W =  $98.2^{\circ}$ C. This is well below the limit of  $125^{\circ}$ C

This calculation is only an example. Tj will obviously vary depending on the number of loaded outputs, supply voltage, air flow, and the type of board (single layer or multi-layer).

Table 7. Thermal Resistance  $\theta_{\text{JA}}$  for 32-pin LQFP, Forced Convection

# 0200500Single-Layer PCB, JEDEC Standard Test Boards67.8°C/W55.9°C/W50.1°C/WMulti-Layer PCB, JEDEC Standard Test Boards47.9°C/W42.1°C/W39.4°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

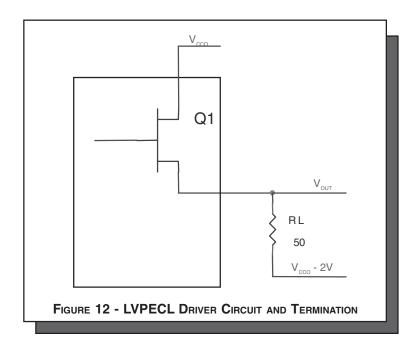
 $\theta_{IA}$  by Velocity (Linear Feet per Minute)

# 1-to-5 Differential-to-3.3V LVPECL Zero Delay Buffer

#### 3. Calculations and Equations.

The purpose of this section is to derive the power dissipated into the load.

LVPECL output driver circuit and termination are shown in Figure 12.



To calculate worst case power dissipation into the load, use the following equations which assume a  $50\Omega$  load, and a termination voltage of  $V_{CC}$  - 2V.

• For logic high, 
$$V_{OUT} = V_{OH\_MAX} = V_{CCO\_MAX} - 1.0V$$

$$(V_{CCO\_MAX} - V_{OH\_MAX}) = 1.0V$$

• For logic low, 
$$V_{OUT} = V_{OL\_MAX} = V_{CCO\_MAX} - 1.7V$$

$$(V_{CCO\_MAX} - V_{OL\_MAX}) = 1.7V$$

Pd\_H is power dissipation when the output drives high. Pd\_L is the power dissipation when the output drives low.

$$Pd_{-}H = [(V_{OH\_MAX} - (V_{CCO\_MAX} - 2V))/R_{L}] * (V_{CCO\_MAX} - V_{OH\_MAX}) = [(2V - (V_{CCO\_MAX} - V_{OH\_MAX}))/R_{L}] * (V_{CCO\_MAX} - V_{OH\_MAX}) = (2V - 1V) * 1V = 20.0mW$$

$$Pd\_L = [(V_{OL\_MAX} - (V_{CCO\_MAX} - 2V))/R_{_L}] * (V_{CCO\_MAX} - V_{OL\_MAX}) = [(2V - (V_{CCO\_MAX} - V_{OL\_MAX}))/R_{_L}] * (V_{CCO\_MAX} - V_{OL\_MAX}) = (2V - 1.7V) * 1.7V = 10.2mW$$

Total Power Dissipation per output pair = Pd\_H + Pd\_L = 30.2mW

### ICS8634-01 1-to-5 Differential-to-3.3V LVPECL Zero Delay Buffer

### RELIABILITY INFORMATION

### Table 8. $\theta_{\text{JA}} \text{vs. A} \text{IR Flow Table}$

### $\theta_{\text{JA}}$ by Velocity (Linear Feet per Minute)

	0	200	500
Single-Layer PCB, JEDEC Standard Test Boards	67.8°C/W	55.9°C/W	50.1°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	47.9°C/W	42.1°C/W	39.4°C/W

NOTE: Most modern PCB designs use multi-layered boards. The data in the second row pertains to most designs.

### TRANSISTOR COUNT

The transistor count for ICS8634-01 is: 2969



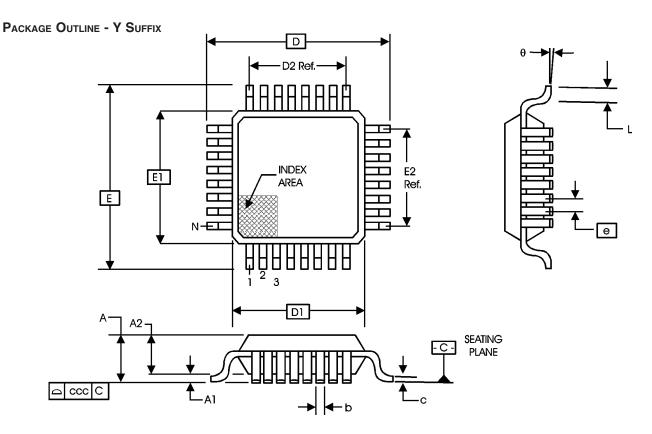


TABLE 9. PACKAGE DIMENISIONS

	JEDEC VARIATION ALL DIMENSIONS IN MILLIMETERS							
OVMPOL	ВВА							
SYMBOL	MINIMUM	MINIMUM NOMINAL						
N		32						
Α			1.60					
<b>A</b> 1	0.05		0.15					
A2	1.35	1.40	1.45					
b	0.30	0.37	0.45					
С	0.09		0.20					
D		9.00 BASIC						
D1		7.00 BASIC						
D2		5.60						
E		9.00 BASIC						
E1		7.00 BASIC						
E2		5.60						
е		0.80 BASIC						
L	0.45	0.60	0.75					
θ	0°		7°					
ccc			0.10					

Reference Document: JEDEC Publication 95, MS-026



# ICS8634-01 1-to-5 Differential-to-3.3V LVPECL ZERO DELAY BUFFER

### TABLE 10. ORDERING INFORMATION

Part/Order Number	Marking	Package	Count	Temperature
ICS8634BY-01	ICS8634BY-01	32 Lead LQFP	250 per tray	0°C to 70°C
ICS8634BY-01T	ICS8634BY-01	32 Lead LQFP on Tape and Reel	1000	0°C to 70°C

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## ICS8634-01 1-to-5 Differential-to-3.3V LVPECL Zero Delay Buffer

REVISION HISTORY SHEET					
Rev	Table	Page	Description of Change		
Α		1	Updated Block Diagram.	11/2/01	
А	3A 6	3 5	Added note at bottom of the table. Added Note 6.	11/20/01	